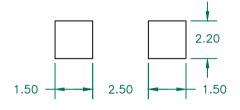
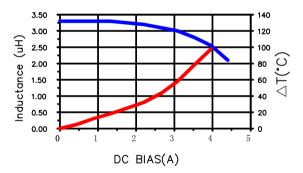
MGV04023R3M-10

PHYSICAL DIMENSIONS:

| Α | 4.50 | \pm | 0.50 |
|---|------|-------|------|
| В | 4.10 | \pm | 0.30 |
| С | 2.00 | ± | 0.30 |
| D | 1.50 | ± | 0.30 |
| Ε | 1.00 | ± | 0.50 |

LAND PATTERNS FOR REFLOW SOLDERING

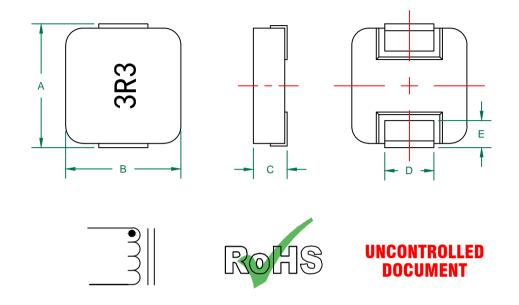




ELECTRICAL SPECIFICATION @ 25°C

| | Min | Norm | Max |
|---|------|------|-------|
| INDUCTANCE (uH) L @ 100 KHz/0.25V ± 20% | 2.64 | 3.30 | 3.96 |
| DCR (Ω) | | | 0.087 |

| Saturation Current ³ Isat (A) | 4.00 |
|---|------|
| Temperature Rise Current Irms ⁴ (A) | 2.50 |



NOTES: UNLESS OTHERWISE SPECIFIED

- 1.COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2.OPERATION TEMPERATURE RANGE: -40°C~+125°C (INCLUDING SELF-HEATING).
- 3.SATURATION CURRENT Isat IS DEFINED AS MAXIMUM AMOUNT OF CURRENT BY WHICH INDUCTANCE WILL DROP BY TYPICAL VALUE OF 30% OF INITIAL INDUCTANCE (Ta=25±5°C).
- 4.TEMPERATURE RISE CURRENT (Irms): DC CURRENT THAT CAUSES THE TEMPERATURE RISE ($\Delta T \leq 40^{\circ}$ C) FROM 25°C AMBIENT.

| | DIMENSIONS ARE IN mm. | | | This print is the property of Laird | | | | | |
|----------|-----------------------|------------|-----|---|-------------|---------|--------|------------|--|
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| — | | | | MGV04023R3M-10 | В | | WER | QIU | |
| <u> </u> | LIDDATE LOGG | 04 /04 /45 | | | | INDU | CTOR | | |
| В | | 04/21/15 | | | NTS | | SHEET: | | |
| Α | ORIGINAL DRAFT | 02/19/13 | QIU | CAD # TO | OL # | | | | |
| REV | DESCRIPTION | DATE | INT | MGV04023R3M−10−B | ~~ , | - | 1 | of 1 | |